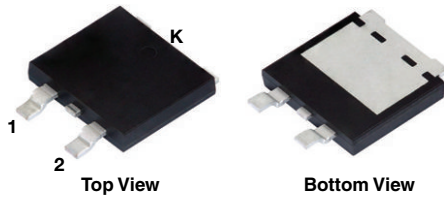
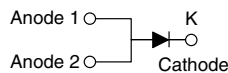


## Surface-Mount ESD Capability Rectifiers

### eSMP® Series SMPD (TO-263AC)



#### SE20DX



### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	20 A
$V_{RRM}$	100 V, 200 V, 400 V, 600 V
$I_{FSM}$	150 A
$V_F$ at $I_F = 20$ A ( $T_A = 125$ °C)	1.03 V
$I_R$	25 $\mu$ A
$T_J$ max.	175 °C
Package	SMPD (TO-263AC)
Circuit configurations	Single

### FEATURES

- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### MECHANICAL DATA

#### Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** as marked

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE20DB	SE20DD	SE20DG	SE20DJ	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V
Maximum DC forward current	$I_F^{(1)}$	20				A
	$I_F^{(2)}$	3.9				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	150				A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175				°C

#### Notes

(1) With heatsink

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 10 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.98	-	V
	I <sub>F</sub> = 20 A			1.10	1.20	
	I <sub>F</sub> = 10 A	T <sub>A</sub> = 125 °C		0.88	-	
	I <sub>F</sub> = 20 A			1.03	1.15	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	25	μA
		T <sub>A</sub> = 125 °C		38	150	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	3000	-	ns
Typical junction capacitance	4.0 V, 1 MHz		C <sub>J</sub>	150	-	pF

**Notes**

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE20DB	SE20DD	SE20DG	SE20DJ	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)(2)</sup>	60				°C/W
	R <sub>θJC</sub> <sup>(3)</sup>	1.6				

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>θJA</sub>
- (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R<sub>θJA</sub> - junction to ambient
- (3) With infinite heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T <sub>A</sub> = 25 °C unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V <sub>C</sub>	H3B	> 8 kV

ORDERING INFORMATION (Example)					
STANDARD	PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SMPD (TO-263AC)	SE20DJ-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel
SMPD (TO-263AC)	SE20DJHM3/I <sup>(1)</sup>	0.54	I	2000/reel	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

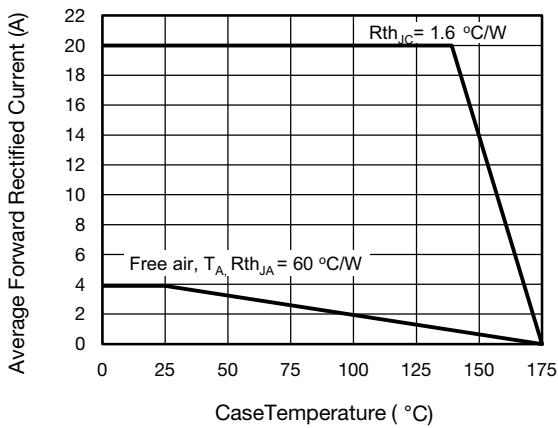


Fig. 1 - Forward Current Derating Curve

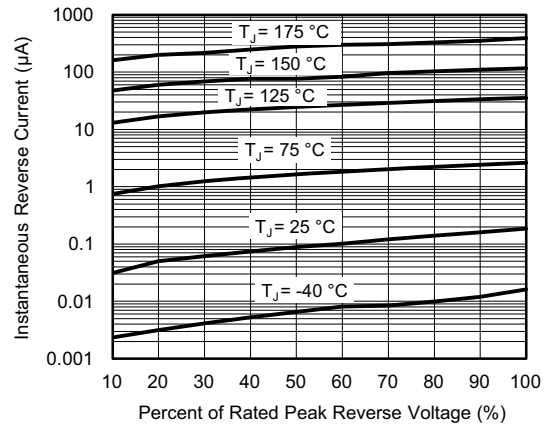


Fig. 4 - Typical Reverse Leakage Characteristics

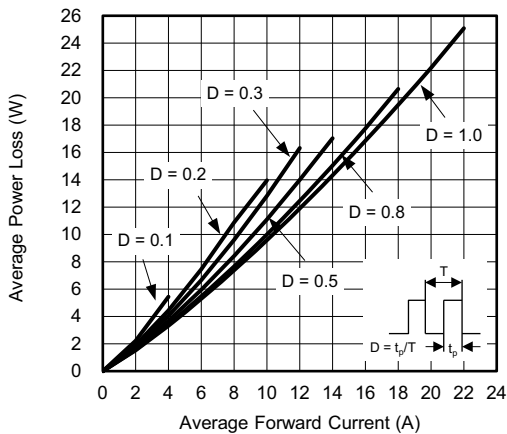


Fig. 2 - Forward Power Loss Characteristics

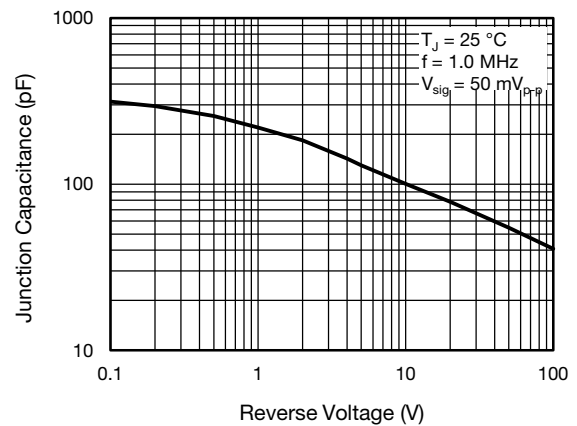


Fig. 5 - Typical Junction Capacitance

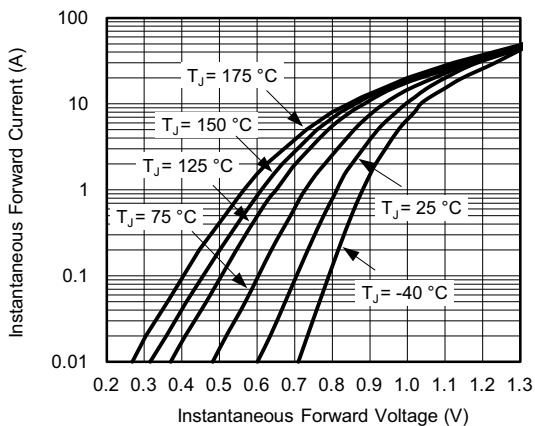


Fig. 3 - Typical Instantaneous Forward Characteristics

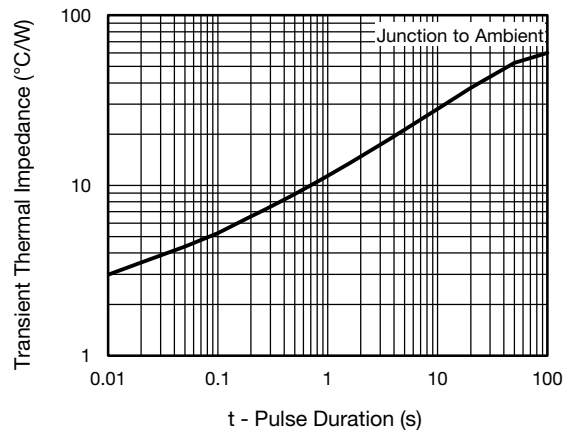
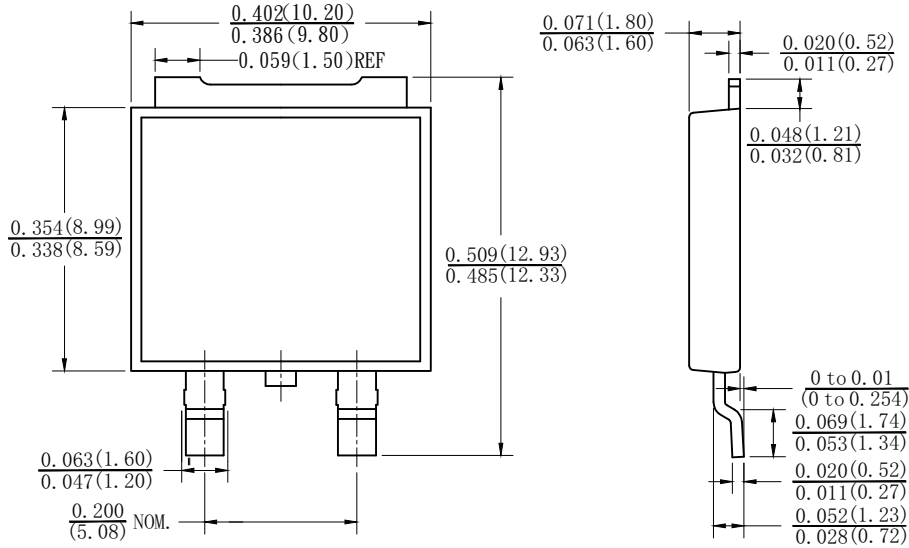


Fig. 6 - Typical Transient Thermal Impedance

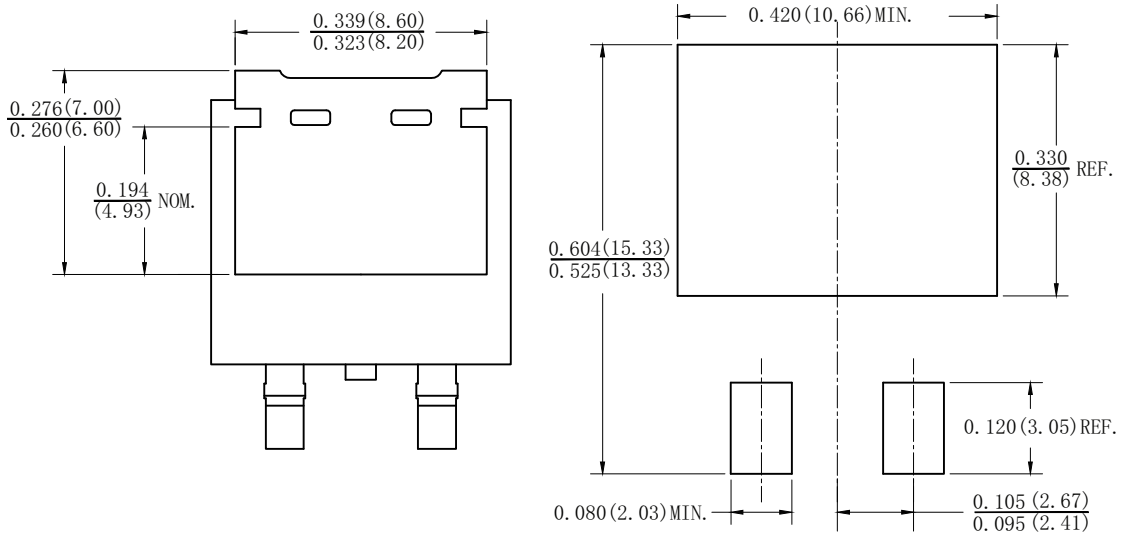


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPD (TO-263AC)



Mounting Pad Layout





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